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Microstructural, surface and interface properties of zirconium doped HfO₂ thin films grown by RF co-sputtering technique

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Abstract

 $Hf_{1-x}Zr_xO_2$ gate dielectric thin films were deposited on Si (100) substrates by RF reactive cosputtering with the variation in the RF power of zirconium target. The compositional, morphological, structural and optical properties of $Hf_{1-x}Zr_xO_2$ films with various Zr content are systematically investigated by X-ray photoelectron spectroscopy, scanning electron microscopy, X-ray diffraction and Raman spectroscopy, respectively. The electrical properties of the cosputtered thin films were studied by capacitance-voltage and current density-voltage measurements. The Zr content in sputtered $Hf_{1-x}Zr_xO_2$ film was found to be increased up to 19 % at a RF power of 90 W. With the increase in Zr content, the enhancement in the crystalline behaviour of co-sputtered film is observed. FESEM micrographs depicted the increase in the grain size with rise in RF power of Zr target. The major generated phase of $Hf_{1-x}Zr_xO_2$ film is the zirconium-substituted monoclinic phase as revealed from Raman spectroscopy study. The oxide (Q_{ox}) and interface charge density (D_{it}) were estimated from the high frequency (1 MHz) Capacitance–voltage curve. The D_{it} has a minimum value for the film deposited at a RF power of 45 W for Zr target, which is due to the reduction of unsaturated bonds and structural relaxation at the $Hf_{1-x}Zr_xO_2/Si$ interface.

Keywords: High-k gate dielectrics; $Hf_{1-x}Zr_xO_2$ films; Reactive co-sputtering; XPS; Surface and interface characterizations

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